



General Description

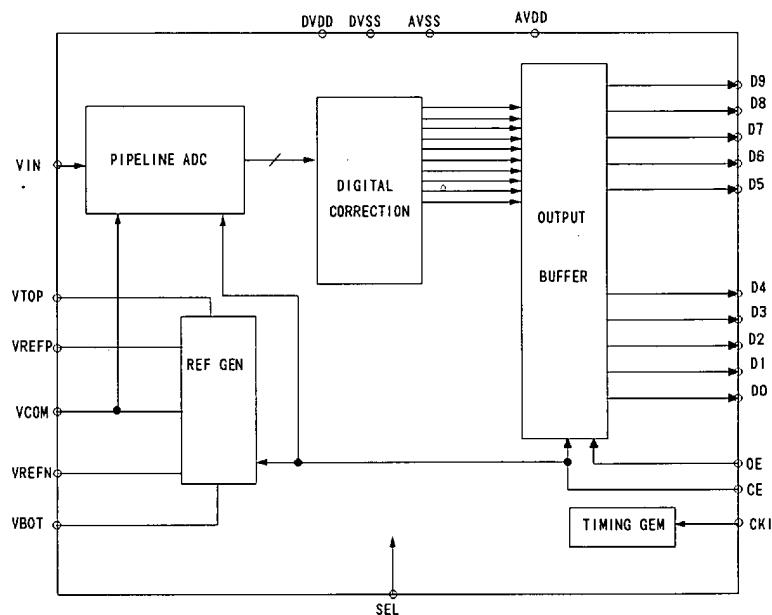
AK5482 is a 10bit 20MHz AD Converter with Pipeline Architecture.

By advanced CMOS Technology, high conversion performance is realized under low power consumption at +3V single power supply.

Features

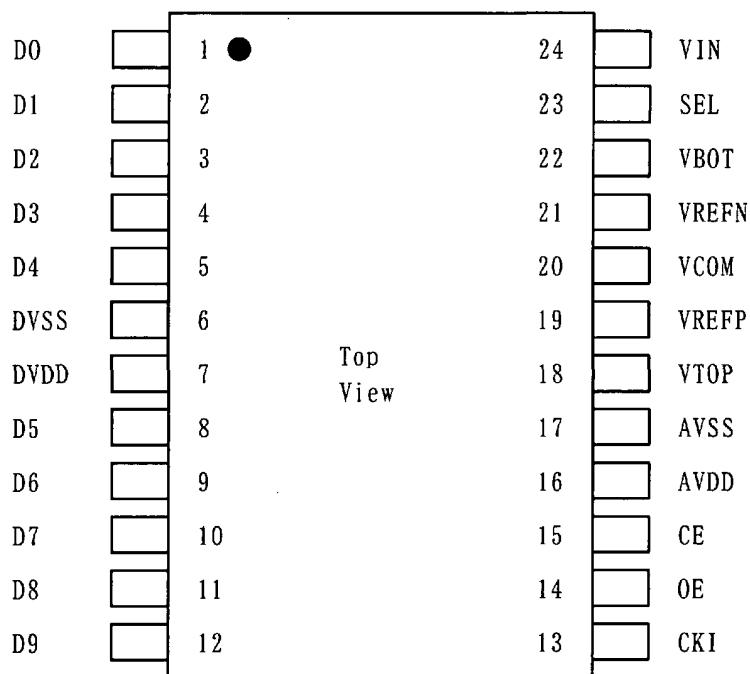
- Monolithic CMOS A/D Converter
- Resolution :10Bit
- Sampling Rate :20MHz
- Integrated Sample & Hold Circuit
- Analog Input Range :1Vp-p (Single End)
- Low Voltage Single Power Supply :+3V (min.)
- Interface to CMOS logic
- Output Format :Binary (BOTTOM=000H , TOP=3FFH)
- Integrated Vref Circuit :(TYP. 1V(Bottom)..2V(Top))
- Tristate Digital Output available
- Stand-by mode
- Low power consumption :50mW(TYP. at 20MSPS)
40mW(TYP. at 15MSPS)
(EXCLUDING OUTPUT DRIVE CURRENT)
- No Calibrations required
- Linearity: Differential(DNL) +-0.5 LSB(TYP.)
Integral (INL) +-1.5 LSB(TYP.)
- Compact Package : 24PIN VSOP

AK5482block Diagram



■ Ordering Guide

AK5482 -20°C+85°C 24pin VSOP(0.65mm pitch)

■ Pin Layout

**Specifications subject to change without notice

■ Pin/Function

Pin No.	Pin Name	IO	Function
1	D0	O	Digital Output D0(LSB) Hi Impedance when OE or CE is high
2	D1	O	Digital Output D1 Hi Impedance when OE or CE is high
3	D2	O	Digital Output D2 Hi Impedance when OE or CE is high
4	D3	O	Digital Output D3 Hi Impedance when OE or CE is high
5	D4	O	Digital Output D4 Hi Impedance when OE or CE is high
6	DVSS	P	Digital Ground Pin
7	DVDD	P	Digital Power Supply Pin
8	D5	O	Digital OUTPUT D5 Hi Impednace when OE or CE is high
9	D6	O	Digital OUTPUT D6 Hi Impednace when OE or CE is high
10	D7	O	Digital OUTPUT D7 Hi Impednace when OE or CE is high
11	D8	O	Digital OUTPUT D8 Hi Impednace when OE or CE is high
12	D9	O	Digital OUTPUT D9 Hi Impednace when OE or CE is high
13	CKI	I	Sampling Clock Input Pin
14	OE	I	Output Enable Output (D0...D9) is active at OE=LOW, Hi Impedance when High
15	CE	I	Chip Enable (Power Down) Pin Chip Operates at LOW, Power Down & Hi Impedance at High
16	AVDD	P	Analog Vdd Analog Power Supply Pin
17	AVSS	P	ANALOG VSS Analog Ground Pin

Pin No.	Pin Name	IO	Function
18	VTOP	IO	VREF Top Voltage IO Pin (TYP.2V) Analog Input (VIN) Upper Limit Vref Pin Assigned to Input Pin under EXT mode Connected to AVSS with a 1uF capacitor at INT mode
19	VREFP	O	Vref Pin for Internal circuit (VREFP = VCOM + 0.25V) Normally connected to AVSS with 1uF Capacitor
20	VCOM	O	REFERENCE CENTER (ADC COMMON) Intefnal Circuit Common Voltage Output (typ.1.5V) Normally connected to AVSS with 1uF Capacitor
21	VREFN	O	Vref Pin for Internal Circuit (VREFN = VCOM - 0.25V) Normally connected to AVSS with 1uF Capacitor
22	VBOT	IO	VREF Bottom Voltage IO Pin (TYP.1V) Analog Input (VIN) Lower Limit Vref Pin Assigned to Input Pin under EXT mode Connected to AVSS with a 1uF capacitor at INT mode
23	SEL	I	Operation Mode Selection Pin Vref mode and Maximum Sampling Frequency are determined VSS: Internal Vref(INT)Mode & 20MHz Mode VBOT: External Vref(EXT)Mode & 20MHz Mode VDD: Internal Vref(INT)Mode & 15MHz Mode VTOP: External Vref(EXT)Mode & 15MHz Mode
24	VIN	I	

NOTE: I:INPUT O:OUTPUT IO:INPUT & OUTPUT P:POWER

Absolute Maximum Rating

(AVSS,DVSS=0V,All Voltages with respect to ground)

Parameter	Symbol	Condition	Rating	Unit
Power Supplies (Analog) (Digital)	AVDD		6	V
	DVDD		6	V
Analog Input Voltage(VIN)	VINA		AVDD + 0.3 ~ AVSS - 0.3	V
Digital Input Voltage	VINL		DVDD + 0.3 ~ DVSS - 0.3	V
Digital Output Voltage	VONL		DVDD + 0.3 ~ DVSS - 0.3	V
Reference Voltage	VINR		AVDD +0.3 ~ AVSS - 0.3	V
Temperature (Ambient) (Storage)	TA Tstg		-20~85 -40~+125	°C

Warining: Operation at or beyond these limits may result in permanent damage to the device. Normal operation is not guaranteed at these extremes.

Recommended Operating Conditions

(DVSS,AVSS=0V)

Parameter	Symbol	Condition	min	typ	max	Unit
Power Supply Voltage	AVDD	(note 1)	3.0	3.3	3.6	V
	DVDD		3.0	3.3	3.6	V
Analog Input Range	AIN	INT mode EXT mode	0.85 0.9	0.95 1.0	1.05 1.1	Vp-p Vp-p

(note 1):All voltages are with respect to Ground

Electrical Characteristics

1)Digital Characteristics

(AVDD=DVDD=3.0..3.6V , AVSS=DVSS=0V, Ta=TAMIN~TAMAX°C
Measurement under static state.)

Parameter	Symbol	Condition	min	typ	max	unit
Hi Level Input Voltage	VIH		0.7DVDD			V
Lo Level Input Voltage	VIL				0.3DVDD	V
Hi Level Output Voltage	VOH	IOH=-3mA	0.7DVDD			V
Lo Level Output Voltage	VOL	IOL=3mA			0.3DVDD	V
Hi Level Input Current	IIH	VIH=DVDD	-10		10	uA
Lo Level Input Current	IIL	VIL=0V	-10		10	uA
HI-Z Output Current(HI)	IOZH	OE= DVDD			10	uA
HI-Z Output Current(LO)	IOZL	OE= DVDD	-10			uA

2)Analog Characteristics

(AVDD,DVDD=3.0..3.6V , DVSS,AVSS=0V, Ta=25°C
;VTOP=2.0V VBOT=1.0V:)

Parameter	Symbol	Conditions	min	typ	max	Unit
Resolution	RES		10			BITS

2-1 DC Accuracy

Parameter	Symbol	Conditions	min	typ	max	Unit
Integral Non Linearity	INL	Fs=18MHz (@20MHz mode) Fs=15MHz (@15MHz mode)		+1.5	+2.5	LSB
Differential Non Linearity	DNL			+0.5	+1.0	LSB
Offset Voltage	EOB	TO VBOT	-100		+100	mV
	EOT	TO VTOP(note2)	-100		+100	mV
Gain Error				1		%FS

(note2) Offset Voltage shows the difference between VIN and VBOT(VTOP)
at Digital Outputs are all zero(all one).

2-2 Power Supplies

Parameter	Symbol	Conditions	min	typ	max	Unit
Power Supply Current(Analog)	IA+	Fin=1MHz FS=20MHz FS=15MHz*		14.5 11.0	18 14	mA mA
Power Supply Current (Digital)	ID+	Fin=1MHz NOTE3 FS=20MHz FS=15MHz*		5.0 3.5	8.0 7.0	mA mA
Power Down mode Current (Analog) (Digital)	IAS IDS				0.1 0.1	mA mA

(note3) Measurement under CL=10pF to each D0..D9 Output Pin
*When 15MHz is selected by SEL pin

2-3 Analog Input

Parameter	Symbol	Conditions	min	typ	max	Unit
Analog Voltage Range (Single End)	AIN	INT mode EXT mode	0.85 0.9	0.95 1.0	1.05 1.1	Vpp Vpp
Analog Input Current	AIH	VIN=2.0V			10	uA
Analog Input Current	AIL	VIN=1.0V	-10			uA
Input Capacitance	CIN			10		pF
Analog Input Bandwidth	BW	-1dB		21		MHz

2-4 Voltage Reference

2-4-1 Internal VREF Output (INT Mode)

Parameter	Symbol	Conditions	min	typ	max	Unit
Vref Output Voltage (Bottom)	VBOTI		0.85	0.95	1.05	V
Vref Output Voltage (Top)	VTOPI		1.85	1.90	2.05	V
Vref Output Current	AVR		-0.1		0.1	mA

2-4-2 External VREF Input Conditions(EXT Mode)

Parameter	Symbol	Conditions	min	typ	max	Unit
Vref Input Voltage Bot	VBOTE	(note 4)	0.85	0.95	1.05	V
Vref Input Voltage Top	VTOPE	(note 4)	1.85	1.95	2.05	V
Vref Input Impedance	ZTBE	VBOT - VTOP	100	200		KOHM

(note 4:Voltage from VBOTE to VTOPE are subjected to the same range of the Input Voltage Range(item 2-3).

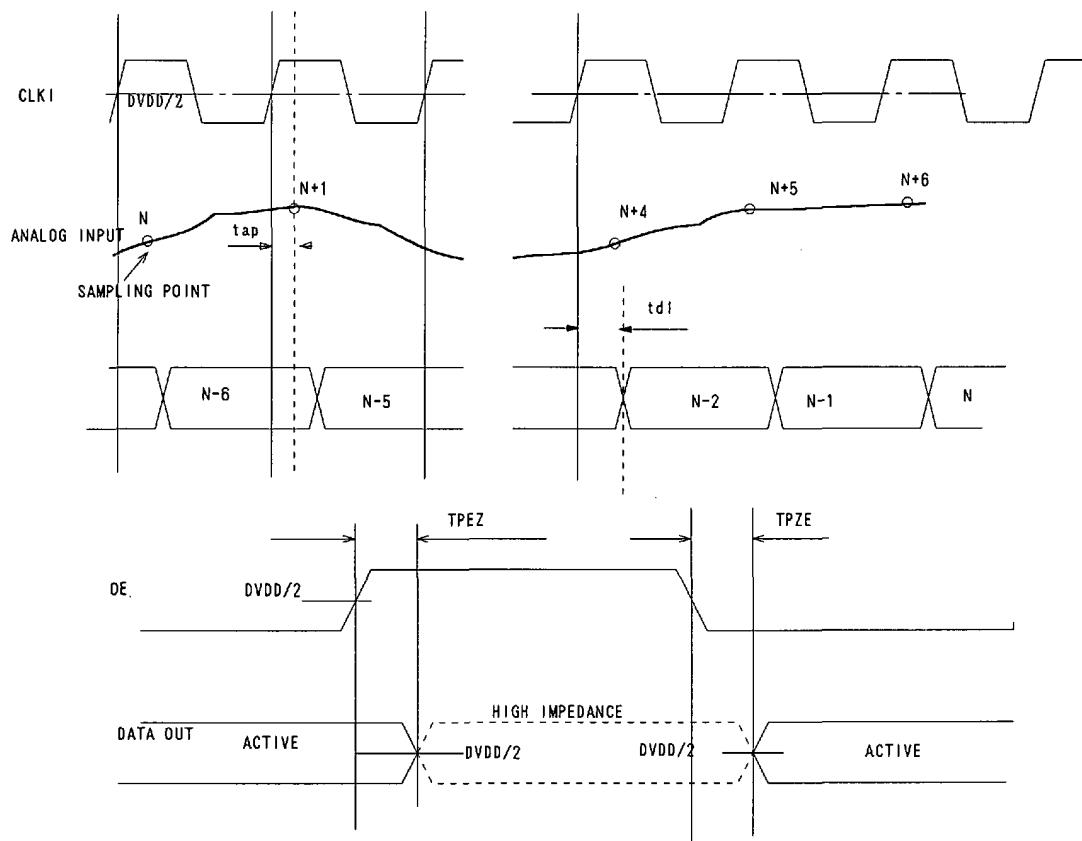
2-5 Dynamic Characterisitcs

Parameter	Symbol	Conditions	min	typ	max	Unit
S/(N+D)	SND	FS=18MHz Fin=1MHz		56		dB
S/N	SNR	FS=18MHz FIN=1MHz		58		dB

2-6 Switching Characteristics

(AVDD,DVDD=3.0....3.6 V, AVSS,DVSS=0V, Ta=TAMIN~TAMAX°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. Conversion Rate	Fcmax		18			MHz
Min. Conversion Rate	Fcmin				0.5	MHz
Clock HI period	tpw1	20MHZ mode	25			ns
Clock LO period	tpw0	20MHZ mode	25			ns
Clock Duty	DUTY	15MHz mode	45	50	55	%
Pipeline Delay	tpd		6	6	6	CLKIN
Sampling Delay	tap			2	4	ns
Date Output Delay	tdl	CL=20 pF		7	12	ns
Tristate Disable Delay	TPEZ	ACTIVE->HI Z		20		ns
Tristate Enable Delay	TPZE	HI Z->ACTIVE		20		ns



Digital Logic

Digital Output

Relation between Input and Digital Output

Input Voltage	Digital Output Code									
	MSB									LSB
VTOP					1	1	1	1	1	1
:									:	
:					1	0	0	0	0	0
:					0	1	1	1	1	1
VBOT					0	0	0	0	0	0

Output Code with CE/OE setting

OE	CE	D0	D1	D2	D3	D4	D5	D6	D7	D8	D9
LO	LO	P	P	P	P	P	P	P	P	P	P
HI	LO	Z	Z	Z	Z	Z	Z	Z	Z	Z	Z
LO	HI	Z	Z	Z	Z	Z	Z	Z	Z	Z	Z
HI	HI	Z	Z	Z	Z	Z	Z	Z	Z	Z	Z

NOTE: P: Positive output

Z:High Impedance

Vref Mode Selection(by SEL pin)

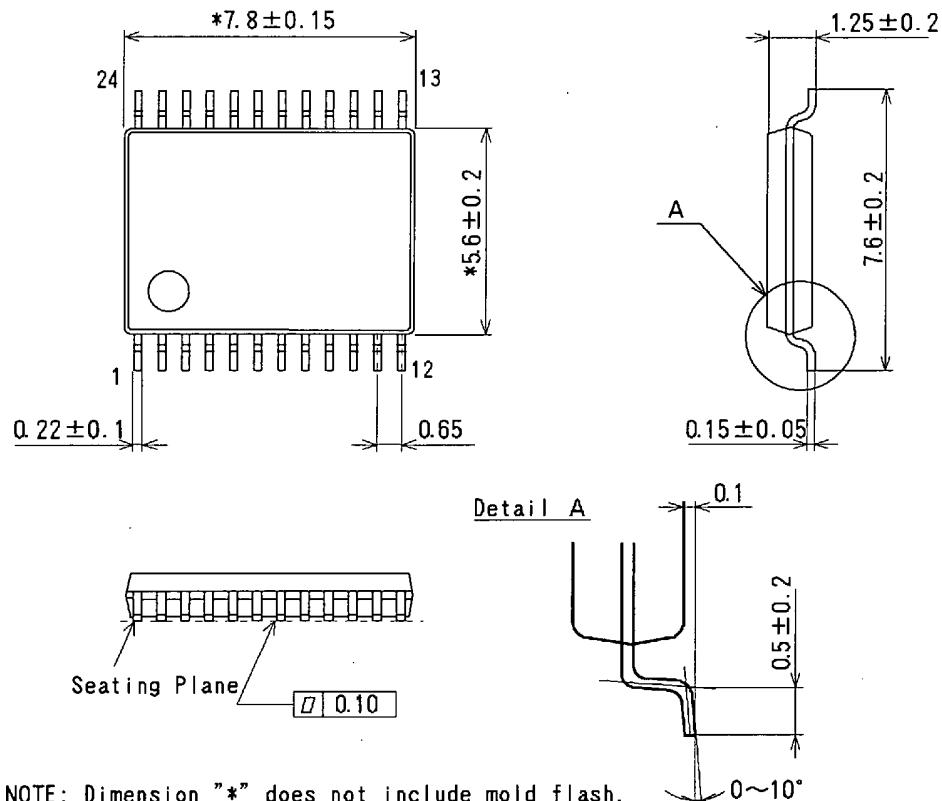
Connection	MODE	Operation
VSS OR VDD	INT MODE	Input Range is determined by Internal Vref Circuit. Internal Vref voltages are supplied through VTOP (typ. 2V) and VBOT (typ. 1V).
VBOT OR VTOP	EXT MODE	AD Conversion is performed based on External Vref. External Vref voltages are fed through VTOP (typ. 2V) and VBOT (typ. 1V).

Frequency Mode Selection(By SEL pin)

Connection	MODE	Operation
VSS OR VBOT	20MHz MODE	20MHz Mode is selected Fcmax is 20MHz
VDD OR VTOP	15MHz MODE	15MHz Mode is selected Fcmax is 15MHz Power consumption is lower than 20MHz mode

Package

● 24pin VSOP (Unit: mm)

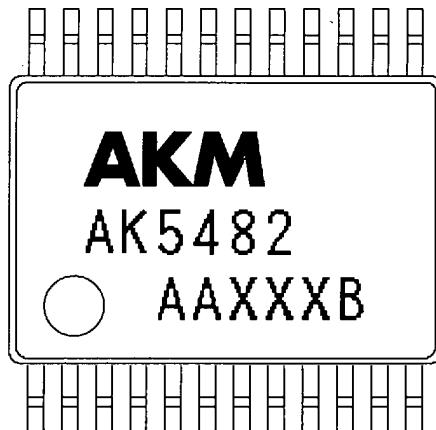


NOTE: Dimension "*" does not include mold flash. $0 \sim 10^\circ$

■ Package & Lead frame material

Package molding compound: Epoxy
 Lead frame material: Cu
 Lead frame surface treatment: Solder plate

Marking

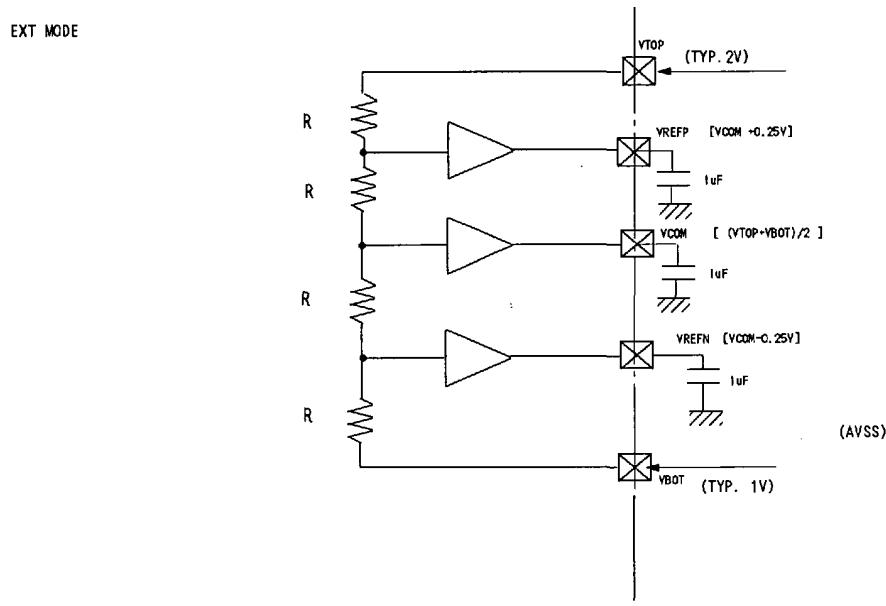
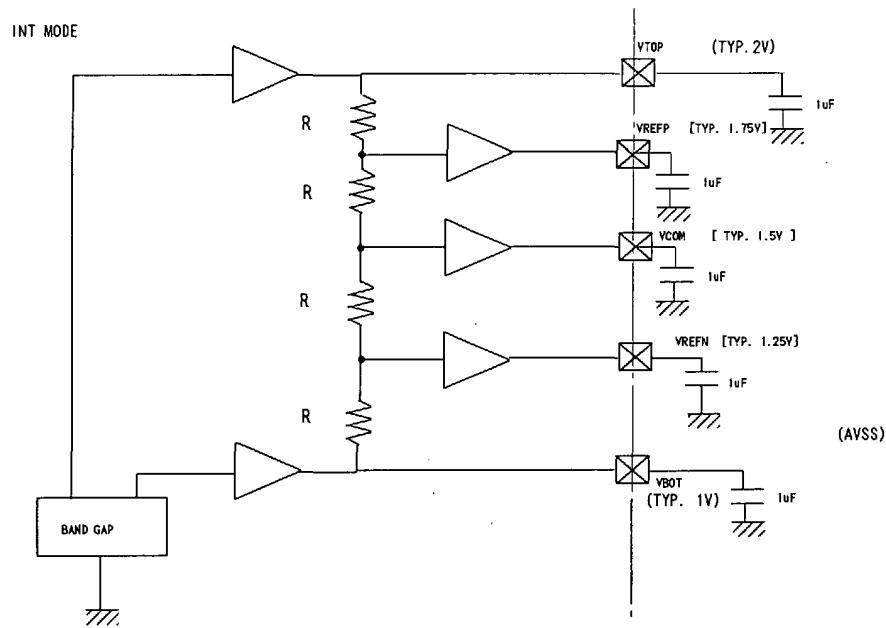


Contents of AAXXXB

AA: Lot#(alphabet)

XXXB: Date Code(X:numbers,B:alphabet)

System Design



$$R_{\text{total}} = 4 * R = 100 \text{ k}\Omega \text{ (MIN.)}$$

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